IGBT - Field Stop

600 V, 60 A

FGH60N60SFD

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 2.3 \text{ V}$ @ $I_C = 60 \text{ A}$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

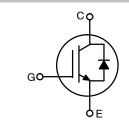
Applications

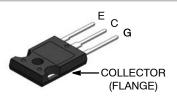
• Solar Inverter, UPS, Welder, PFC



ON Semiconductor®

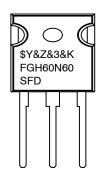
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TO-247-3LD CASE 340CK

MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Numeric Date Code

&K = Lot Code

FGH60N60SFD = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Descript	Symbol	Ratings	Unit	
Collector to Emitter Voltage	V _{CES}	600	V	
Gate to Emitter Voltage	V _{GES}	±20	V	
Transient Gate-to-Emitter Voltage	1	±30		
Collector Current	T _C = 25°C	I _C	120	Α
Collector Current	T _C = 100°C	1	60	Α
Pulsed Collector Current	T _C = 25°C	I _{CM} (Note 1)	180	Α
Maximum Power Dissipation	T _C = 25°C	P _D	378	W
Maximum Power Dissipation	T _C = 100°C	1	151	W
Operating Junction Temperature	TJ	-55 to +150	°C	
Storage Temperature Range	T _{stg}	-55 to +150	°C	
Maximum Lead Temp. for Soldering Purpos	ses, 1/8" from Case for 5 Seconds	T _L	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (IGBT)	-	0.33	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (Diode)	-	1.1	°C/W
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	_	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH60N60SFDTU	FGH60N60SFD	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector to Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 250 μA	600	_	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	$V_{GE} = 0 \text{ V, I}_{C} = 250 \mu\text{A}$	-	0.4	-	V/°C
Collector Cut-Off Current	I _{CES}	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μΑ
G-E Leakage Current	I _{GES}	V _{GE} = V _{GES} , V _{CE} = 0 V	-	-	±400	nA
ON CHARACTERISTICs						
G-E Threshold Voltage	V _{GE(th)}	I_C = 250 μ A, V_{CE} = V_{GE}	4.0	5.0	6.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 60 A, V _{GE} = 15 V	_	2.3	2.9	V
		I _C = 60 A, V _{GE} = 15 V, T _C = 125°C	-	2.5	-	V

^{1.} Repetitive test, Pulse width limited by max. junction temperature.

$\textbf{ELECTRICAL CHARACTERISTICS OF THE IGBT} \ (T_C = 25^{\circ}C \ unless \ otherwise \ noted) \ (continued)$

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ies}	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	_	2820	_	pF
Output Capacitance	C _{oes}		_	350	_	pF
Reverse Transfer Capacitance	C _{res}		_	140	_	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, I_{C} = 60 \text{ A},$	_	22	_	ns
Rise Time	t _r	$R_G = 5 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	_	42	_	ns
Turn-Off Delay Time	t _{d(off)}		_	134	_	ns
Fall Time	t _f		_	31	62	ns
Turn-On Switching Loss	E _{on}		_	1.79	_	mJ
Turn-Off Switching Loss	E _{off}		_	0.67	-	mJ
Total Switching Loss	E _{ts}			2.46	-	mJ
Turn-On Delay Time	t _{d(on)}	V _{CC} = 400 V, I _C = 60 A,	-	22	-	ns
Rise Time	t _r	$R_G = 5 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 125^{\circ}C$	_	44	-	ns
Turn-Off Delay Time	t _{d(off)}		=	144	-	ns
Fall Time	t _f		=	43	-	ns
Turn-On Switching Loss	E _{on}		_	1.88	-	mJ
Turn-Off Switching Loss	E _{off}		_	1.0	_	mJ
Total Switching Loss	E _{ts}		_	2.88	-	mJ
Total Gate Charge	Qg	V _{CE} = 400 V, I _C = 60 A, V _{GE} = 15 V	-	198	-	nC
Gate to Emitter Charge	Q _{ge}		_	22	-	nC
Gate to Collector Charge	Q_{gc}		-	106	-	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_J = 25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V_{FM}	Diode Forward Voltage	I _F = 30 A	T _C = 25°C	-	2.0	2.6	V
			T _C = 125°C	-	1.8	_	
t _{rr}	Diode Reverse Recovery Time	$I_F = 30 \text{ A}, \text{ di}_F/\text{dt} = 200 \text{ A}/\mu\text{s}$	T _C = 25°C	-	47	_	ns
			T _C = 125°C	-	179	_	
Q _{rr}	Diode Reverse Recovery Charge	1	T _C = 25°C	-	83	_	nC
			T _C = 125°C	-	567	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

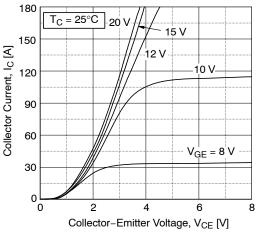


Figure 1. Typical Output Characteristics

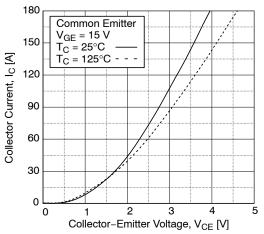


Figure 3. Typical Saturation Voltage Characteristics

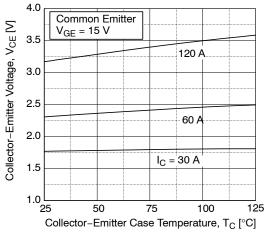


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

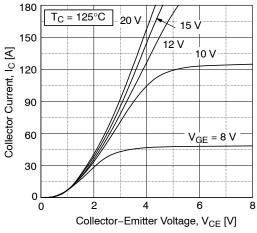


Figure 2. Typical Output Characteristics

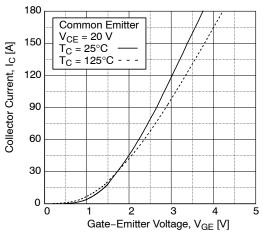


Figure 4. Transfer Characteristics

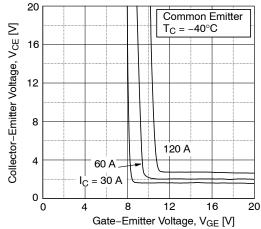


Figure 6. Saturation Voltage vs V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

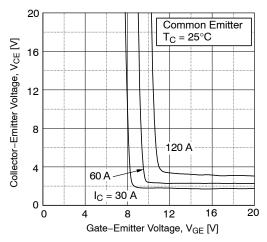


Figure 7. Saturation Voltage vs. V_{GE}

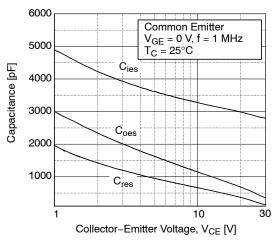


Figure 9. Capacitance Characteristics

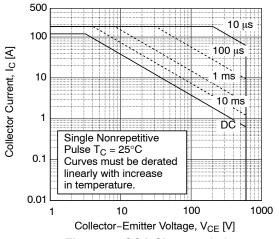


Figure 11. SOA Characteristics

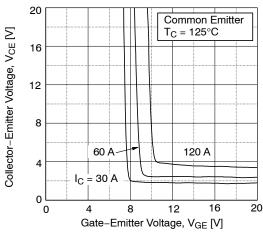


Figure 8. Saturation Voltage vs. V_{GE}

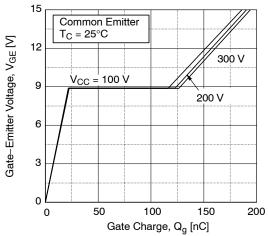


Figure 10. Gate Charge Characteristics

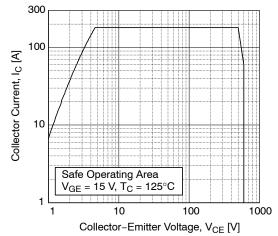


Figure 12. Turn-Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

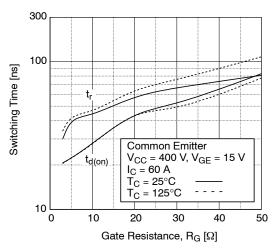


Figure 13. Turn-On Characteristics vs. Gate Resistance

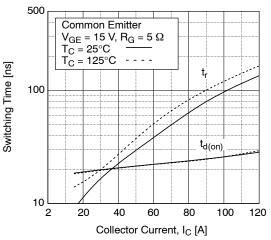


Figure 15. Turn-On Characteristics vs. Collector Current

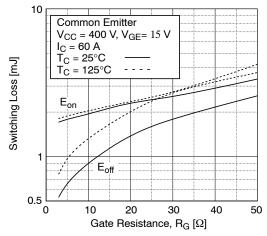


Figure 17. Switching Loss vs. Gate Resistance

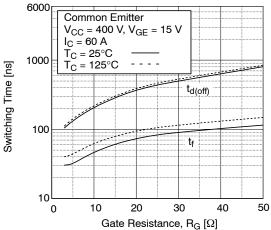


Figure 14. Turn-Off Characteristics vs. Gate Resistance

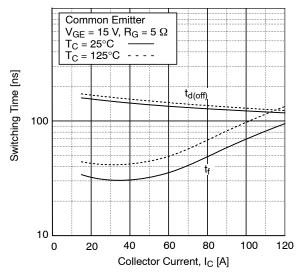


Figure 16. Turn-Off Characteristics vs. Collector Current

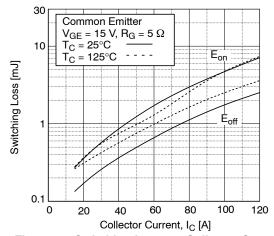


Figure 18. Switching Loss vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

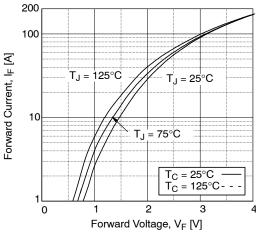


Figure 19. Forward Characteristics

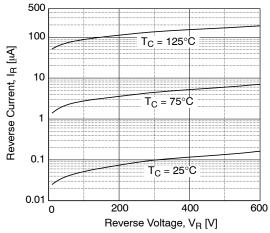


Figure 20. Reverse Current

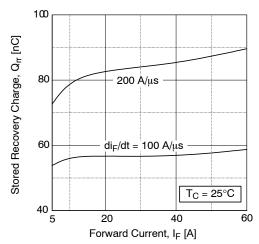


Figure 21. Stored Charge

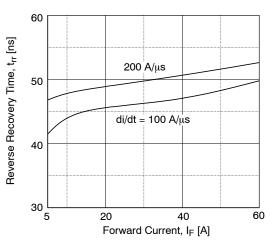


Figure 22. Reverse Recovery Time

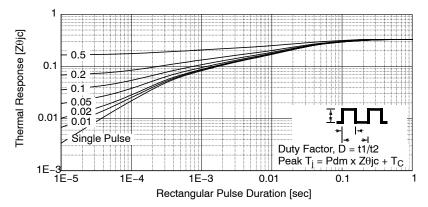


Figure 23. Transient Thermal Impedance of IGBT

TO-247-3LD SHORT LEAD

CASE 340CK ISSUE A





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIM	MILLIMETERS				
DIIVI	MIN	NOM	MAX		
Α	4.58	4.70	4.82		
A 1	2.20	2.40	2.60		
A2	1.40	1.50	1.60		
b	1.17	1.26	1.35		
b2	1.53	1.65	1.77		
b4	2.42	2.54	2.66		
С	0.51	0.61	0.71		
D	20.32	20.57	20.82		
D1	13.08	~	~		
D2	0.51	0.93	1.35		
E	15.37	15.62	15.87		
E1	12.81	?	~		
E2	4.96	5.08	5.20		
е	~	5.56	~		
L	15.75	16.00	16.25		
L1	3.69	3.81	3.93		
ØΡ	3.51	3.58	3.65		
ØP1	6.60	6.80	7.00		
Q	5.34	5.46	5.58		
S	5.34	5.46	5.58		

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 TIG058E8-TL-H
 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
 APT20GT60BRG
 NGTB75N65FL2WAG
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 IGW08T120FKSA1
 IGW75N60H3FKSA1
 HGTG40N60B3
 FGH60N60SMD_F085

 FGH75T65UPD
 STGWA15H120F2
 IKA10N60TXKSA1
 IHW20N120R5XKSA1
 RJH60D2DPP-M0#T2
 IKP20N60TXKSA1

 IHW20N65R5XKSA1
 IDW40E65D2FKSA1